

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hyun Soo KO</td> <td>02/10/2012</td> </tr> <tr> <td>Jae Hoon CHUNG</td> <td>03/12/2012</td> </tr> <tr> <td>Bin Chul IHM</td> <td>02/10/2012</td> </tr> <tr> <td>Moon Il LEE</td> <td>03/06/2012</td> </tr> <tr> <td>Seung Hee HAN</td> <td>02/10/2012</td> </tr> </tbody> </table>		Name	Execution Date	Hyun Soo KO	02/10/2012	Jae Hoon CHUNG	03/12/2012	Bin Chul IHM	02/10/2012	Moon Il LEE	03/06/2012	Seung Hee HAN	02/10/2012
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RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>LG ELECTRONICS INC.</td> </tr> <tr> <td>Street Address:</td> <td>20 Yeouido-dong, Yeongdeungpo-gu</td> </tr> <tr> <td>City:</td> <td>Seoul</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> <tr> <td>Postal Code:</td> <td>150-721</td> </tr> </table>		Name:	LG ELECTRONICS INC.	Street Address:	20 Yeouido-dong, Yeongdeungpo-gu	City:	Seoul	State/Country:	KOREA, REPUBLIC OF	Postal Code:	150-721		
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
<p>Fax Number: (213)623-2211</p> <p>Phone: 2136232221</p> <p>Email: patent@lhlaw.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Lee, Hong, Degerman, Kang &amp; Waimey</p> <p>Address Line 1: 660 S. Figueroa St., 23rd Fl.</p> <p>Address Line 4: Los Angeles, CALIFORNIA 90017</p>													
ATTORNEY DOCKET NUMBER:	2101-5231												
NAME OF SUBMITTER:	Harry S. Lee												

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Total Attachments: 6

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**PATENT**

**REEL: 028097 FRAME: 0270**

**ASSIGNMENT**(1-8) *Insert Name(s) of  
Inventor(s)*(1) KO, Hyun Soo  
(2) CHUNG, Jae Hoon  
(3) IHM, Bin Chul(4) LEE, Moon Il  
(5) HAN, Seung Hee

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) *Insert name of Assignee*(9) **LG ELECTRONICS INC.**(10) *Insert state of Incorporation  
of Assignee*(10) **Korea**(11) *Insert address of Assignee*(11) 20 Yeouido-dong, Yeongdeungpo-gu, Seoul 150-721 Korea  
(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as(12) *Insert identification of  
Invention, such as Title,  
Case Number or Foreign  
Application Number*(12) **TRANSMISSION METHOD AND DEVICE FOR A DOWNLINK  
REFERENCE SIGNAL**

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.

(13) *Insert Date of Signing of  
Application*

(13)

1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

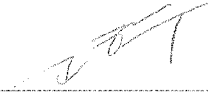
4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby appoints the Attorneys associated with Customer No. 035884 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

10FCCM598US02

1) Date: 10 Feb 2012 Signature of Inventor



2) Date: \_\_\_\_\_ Signature of Inventor

3) Date: 10 Feb 2012 Signature of Inventor



4) Date: \_\_\_\_\_ Signature of Inventor

5) Date: 10 Feb 2012 Signature of Inventor



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1) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_

2) Date: 12 March, 2012 Signature of Inventor Joe Hoon Ong

3) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_

4) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_

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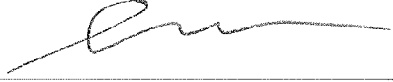
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2) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_

3) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_

4) Date: 6 March, 2012 Signature of Inventor  \_\_\_\_\_

5) Date: \_\_\_\_\_ Signature of Inventor \_\_\_\_\_